

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
YOO HWAN KIM	04/14/2014
YOO SAM NA	04/14/2014
HYUN JIN YOO	04/14/2014
JONG MYEONG KIM	04/14/2014
HYUN HWAN YOO	04/14/2014
RECEIVING PARTY DATA	
Name:	SAMSUNG ELECTRO-MECHANICS CO., LTD.
Street Address:	MAEYOUNG-RO 150 (MAETAN-DONG)
Internal Address:	YOUNGTONG-GU
City:	SUWON-SI, GYEONGGI-DO
State/Country:	REPUBLIC OF KOREA
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14281324
CORRESPONDENCE DATA	
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ATTORNEY DOCKET NUMBER:	093814-0382
NAME OF SUBMITTER:	STEPHEN A. BECKER
SIGNATURE:	/STEPHEN A. BECKER/
DATE SIGNED:	05/19/2014
This document serves as an Oath/Declaration (37 CFR 1.63).	
Total Attachments: 3	

PATENT

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ASSIGNMENT

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I hereby assign to

SAMSUNG ELECTRO-MECHANICS CO., LTD.

having an address at **Maeyoung-Ro 150 (Maetan-Dong), Youngtong-Gu, Suwon-Si, Gyeonggi-Do, Republic of Korea**

hereinafter designated as the Assignee), the entire (100%) right, title and interest for the United States as defined in 35 USC §100, in the invention described in the application identified in this document.

I hereby confirm any prior assignment to Assignee, and to the extent that I have not already done so, agree to assign, and hereby do, sell, assign and transfer unto Assignee and its successors in interest, the full and exclusive right, title and interest in the United States of America and throughout the world, including the right to claim priority under the laws of the United States, the Paris Convention, and any foreign countries, to the inventions as described in the aforesaid application, to the aforesaid application itself, and all divisions, continuations, continuations-in-part, or other applications claiming priority directly or indirectly from the aforesaid application, and any United States or foreign Letters Patent, utility model, or other similar rights which may be granted thereon, including reissues, reexaminations and extensions thereof, and all copyright rights throughout the world in the aforesaid application and the subject matter disclosed therein, these rights, title and interest to be held and enjoyed by Assignee to the full end of the term for which the Letters Patent, utility model, or other similar rights, are granted and any extensions thereof as fully and entirely as the same would have been held by the undersigned had this assignment and sale not been made, and the right to sue for, and recover for past infringements of, or liabilities for, any of the rights relating to any of the applications, patents, utility models, or other similar rights, resulting therefrom, and the copyright rights;

I hereby covenant and agree to execute all instruments or documents required or requested for the making and prosecution of any applications of any type for patent, utility model, or other similar rights, and for copyright, in the United States and in all foreign countries including, but not limited to, any provisional, continuation, continuation-in-part, divisional, renewal or substitute thereof, and as to letters patent any reissue, re-examination, or extension thereof, and for litigation regarding, or for the purpose of protecting title and to the said invention, the United States application for patent, or Letters Patent therefor, and to testify in support thereof, for the benefit of Assignee without further or other compensation than that above set forth;

I hereby covenant that no assignment, sale, license, agreement or encumbrance has been or will be entered into which would conflict with this Assignment.

Legal name of first inventor KIM, Yoo Hwan	
First inventor's signature <i>Kim Yoo Hwan</i>	Date 2014. 4. 14

Legal name of second inventor NA, Yoo Sam	
Second inventor's signature <i>NA Yoo Sam</i>	Date 2014. 4. 14

Legal name of third inventor YOO, Hyun Jin	
Third inventor's signature <i>Yoo Hyun Jin</i>	Date 2014. 04. 14

Legal name of fourth inventor KIM, Jong Myeong	
Fourth inventor's signature <i>Kim Jong Myeong</i>	Date 2014. 04. 14

Legal name of fifth inventor YOO, Hyun Hwan	
Fifth inventor's signature <i>Yoo Hyun Hwan</i>	Date 2014. 04. 14